



Dear Valued Customer

Doc. No.: 2221006  
Issue date: March 1, 2022

Akihiro Hikasa  
General Manager

High Power Device Division  
Power Discrete Headquarters  
ROHM Co., Ltd.

**Notification of Product/Process Change**

This is an announcement of change(s) to the process of the products currently supplied by ROHM Co., Ltd.

We request your acknowledgement of the receipt of this notification within the given period.

Please reply by: October 1, 2022

Title of change	IGBT RGS-Series 650V 8inch wafer factory and TO-247 assembly factory addition		
Affected product(s)	Manufacturer part number		Customer part number
	RGS□□TS65HRC□□, RGS□□TS65D□HRC□□, RGS□□TS65E□HRC□□, RGS80TS65DGC11, RGSX5TS65EGC11		
Detailed description of change	Now		After
	Wafer factory : LAPIS Miyazaki (6inch) Assembly factory : ROHM INTEGRATED SYSTEMS (THAILAND) CO.,LTD.		Wafer factory : LAPIS Miyazaki (6inch)+additional approval of ROHM Shiga (8inch) Assembly factory : RIST+additional approval of sub contract assembly factory (GEM Electoronics (Hefei) Co.,Ltd)
Reason for change	Reason: In order to increase the production capacity and secure a stable product supply.		
Anticipated impact on quality	(form, fit, function, reliability) There is no difference and influence in electrical charecteristics and reliability level. (report in the attached file)		
Identification of change	Changed products can be identified by part number, package outline, marking and lot No.		
Planned first ship date :	March 1, 2023	Sample available schedule : Within 3 weeks from request	
Attachments (data, report)	YES	4M	4ME_2221006(RGS_650V_8inch_and_TO-247GE).pdf RIBl RIBl_2221006(RGS_650V_8inch_and_T O-247GE).pdf
Comments			

		Reply date	
Customer reply	<input type="checkbox"/> 1. Approved. <input type="checkbox"/> 2. Accepted with conditions. <input type="checkbox"/> 3. Rejected.		
Condition for approval / reason for rejection			
Comments			
Customer company name			
Customer signature		Department	
Customer signature		Department	